

SID

Factory: Rot am See

Article:

528

ML6

Provided:

Kracht, Enrico

Customer:

Date:

10.08.2015



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
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A-RS Kupferfolie-018my 330x490mm	50200238	18	VS	1	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	150		2	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		3	
		70	L2		
C-RS-FR4-ML-0.71mm-070+070-TG150-HF	50200813	710		4	A01
		70	L3		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		5	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		6	
		70	L4		
C-RS-FR4-ML-0.71mm-070+070-TG150-HF	50200813	710		7	A02
		70	L5		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	150		8	
A-RS-FR4-Prepreg-1080-TG150-HF	50200641	0		9	
A-RS Kupferfolie-018my 330x490mm	50200238	18	RS	10	

B00

Thickness after Pressing

B00:

2290 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2530 µm

Dmin:

2050 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2400 µm

Tol+:

240 µm

Tol-:

240 µm

Dmax:

2640 µm

Dmin:

2160 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

2196 µm

Version 1.2.14.15

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